





# YJS016NP04A

## ■ NMOS Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A, T_j=25^\circ C$	40	-	-	V
Zero Gate Voltage Drain Current	$I_{DS(on)}$	$V_{DS}=40V, V_{GS}=0V, T_j=25^\circ C$	-	-	1	$\mu A$
		$V_{DS}=40V, V_{GS}=0V, T_j=150^\circ C$	-	-	100	
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V, T_j=25^\circ C$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A, T_j=25^\circ C$	1	1.5	2	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=7A, T_j=25^\circ C$	-	12.5	16	$m\Omega$
		$V_{GS}=4.5V, I_D=4A, T_j=25^\circ C$	-	15.6	21	
Diode Forward Voltage	$V_{SD}$	$I_S=1.6A, V_{GS}=0V, T_j=25^\circ C$	-	0.74	1.2	V
Gate Resistance	$R_G$	$f=1MHz, T_j=25^\circ C$	-	3	-	$\Omega$
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=20V, V_{GS}=0V, f=1MHz, T_j=25^\circ C$	-	1012	-	$pF$
Output Capacitance	$C_{oss}$		-	96	-	
Reverse Transfer Capacitance	$C_{rss}$		-	84	-	
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{GS}=10V, V_{DS}=20V, I_D=7A, T_j=25^\circ C$	-	21.5	-	$nC$
Gate-Source Charge	$Q_{gs}$		-	3	-	
Gate-Drain Charge	$Q_{gd}$		-	4.5	-	
Reverse Recovery Charge	$Q_{rr}$	$I_F=7A, di/dt=100A/\mu s, V_{GS}=0V,$ $V_R=20V, T_j=25^\circ C$	-	8	-	$nC$
Reverse Recovery Time	$t_{rr}$		-	13	-	ns
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DS}=20V, I_D=7A,$ $R_{GEN}=3\Omega, T_j=25^\circ C$	-	7	-	ns
Turn-on Rise Time	$t_r$		-	3.5	-	
Turn-off Delay Time	$t_{D(off)}$		-	29	-	
Turn-off Fall Time	$t_f$		-	6	-	



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Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=-250\mu A, T_j=25^\circ C$	-40	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-40V, V_{GS}=0V, T_j=25^\circ C$	-	-	-1	$\mu A$
		$V_{DS}=-40V, V_{GS}=0V, T_j=150^\circ C$	-	-	-100	
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V, T_j=25^\circ C$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A, T_j=25^\circ C$	-1.1	-1.6	-2.1	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-5A, T_j=25^\circ C$	-	24.6	32	$m\Omega$
		$V_{GS}=-4.5V, I_D=-3A, T_j=25^\circ C$	-	33.4	46	
Diode Forward Voltage	$V_{SD}$	$I_S=-1.5A, V_{GS}=0V, T_j=25^\circ C$	-	-0.78	-1.2	V
Gate Resistance	$R_G$	$f=1MHz, T_j=25^\circ C$	-	16	-	$\Omega$
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=-20V, V_{GS}=0V, f=1MHz, T_j=25^\circ C$	-	1135	-	$pF$
Output Capacitance	$C_{oss}$		-	118	-	
Reverse Transfer Capacitance	$C_{rss}$		-	105	-	
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{GS}=-10V, V_{DS}=-20V, I_D=-5A, T_j=25^\circ C$	-	26	-	$nC$
Gate-Source Charge	$Q_{gs}$		-	3.6	-	
Gate-Drain Charge	$Q_{gd}$		-	4.3	-	
Reverse Recovery Charge	$Q_{rr}$	$I_F=-5A, di/dt=100A/us, V_{GS}=0V, V_R=-20V, T_j=25^\circ C$	-	23	-	$nC$
Reverse Recovery Time	$t_{rr}$		-	31	-	ns
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=-10V, V_{DS}=-20V, I_D=-5A, R_{GEN}=3\Omega, T_j=25^\circ C$	-	7	-	ns
Turn-on Rise Time	$t_r$		-	3.8	-	
Turn-off Delay Time	$t_{D(off)}$		-	90	-	
Turn-off Fall Time	$t_f$		-	53	-	

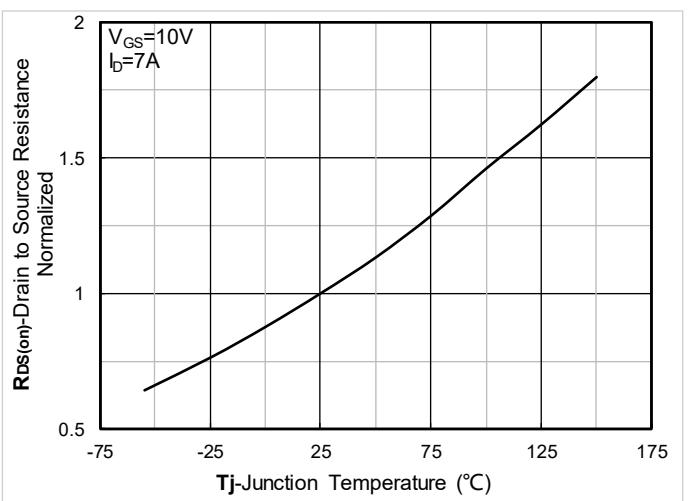
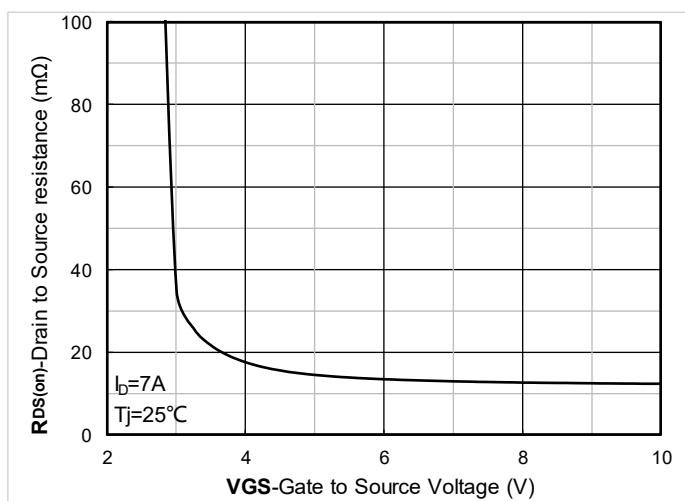
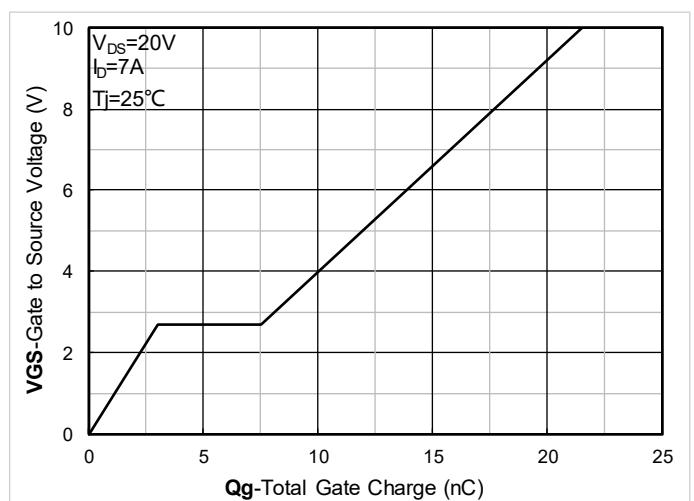
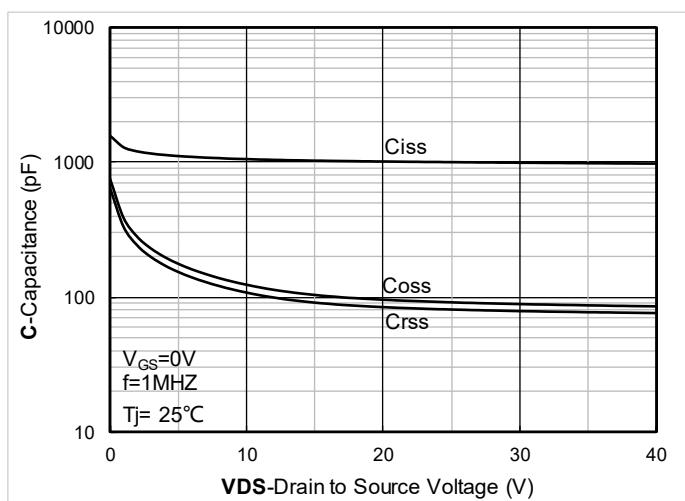
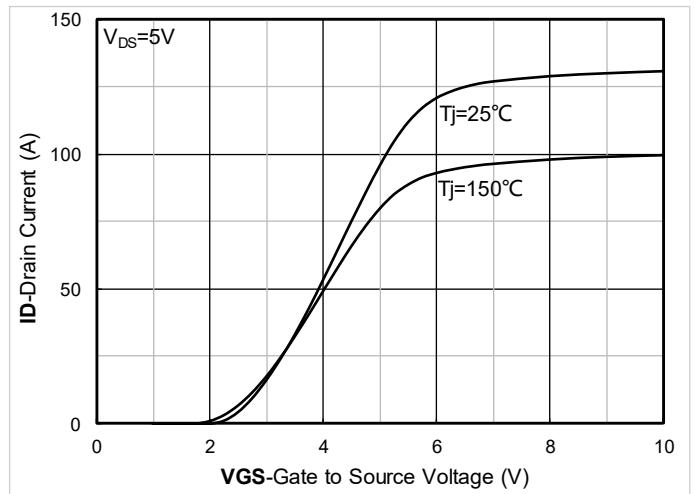
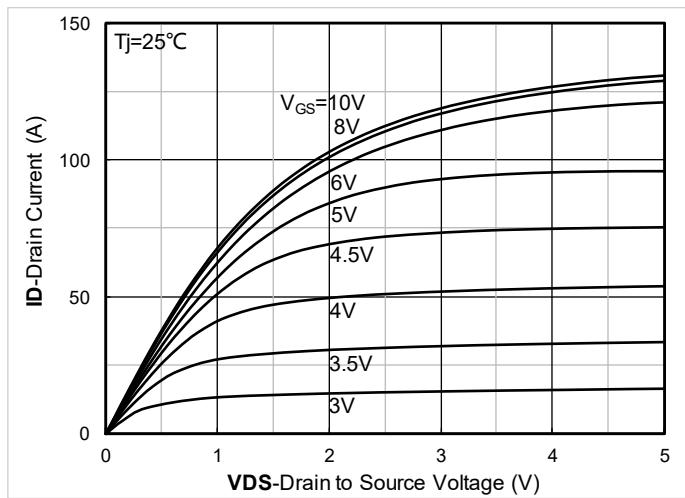
Note:

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. The value of  $R_{\theta JA}$  is measured with the device mounted on the 40mm\*40mm\*1.1mm single layer FR-4 PCB board with 1 in<sup>2</sup> pad of 2oz. Copper, in the still air environment with  $T_A=25^\circ C$ . The maximum allowed junction temperature of  $150^\circ C$ . The value in any given application depends on the user's specific board design.



# YJS016NP04A

## ■ NMOS Typical Electrical and Thermal Characteristics Diagrams





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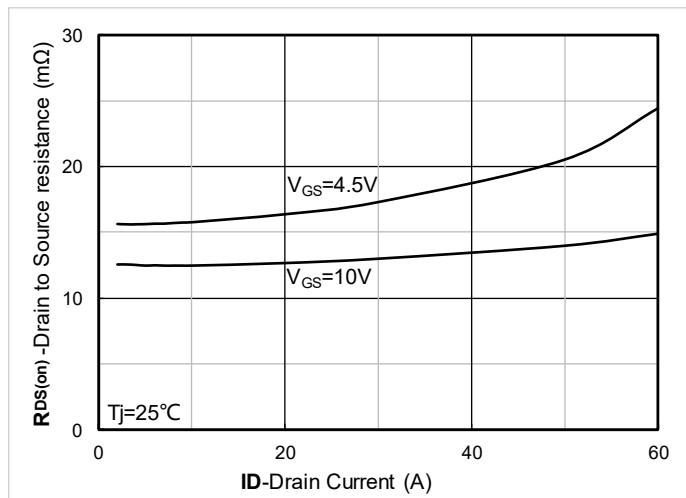


Figure 7.  $R_{DS(on)}$  vs. Drain Current; typical values

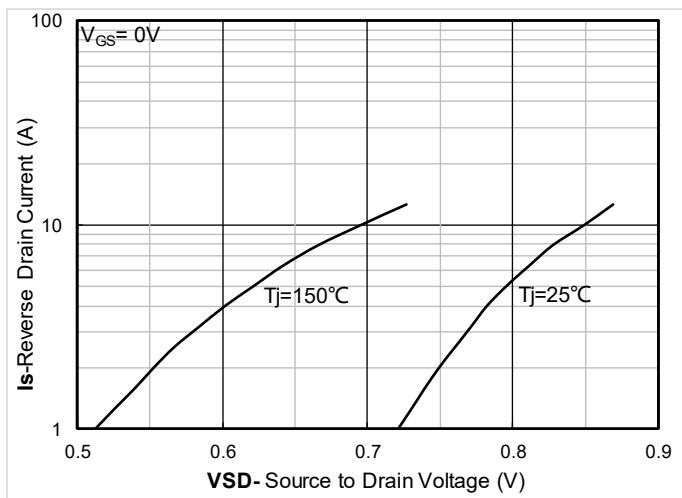


Figure 8. Forward characteristics of reverse diode; typical values

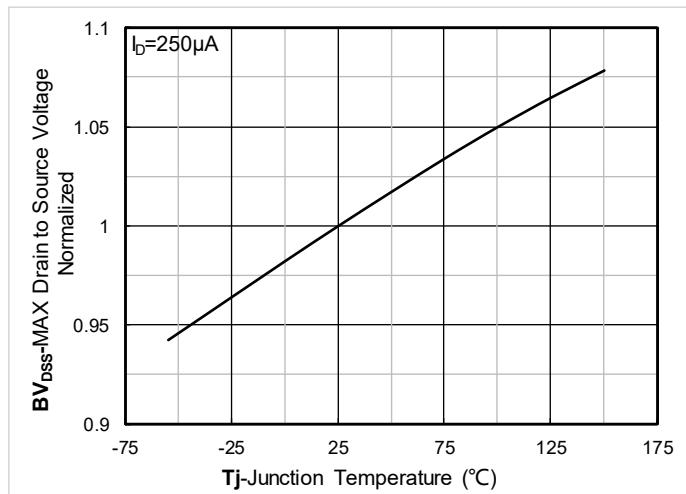


Figure 9. Normalized breakdown voltage

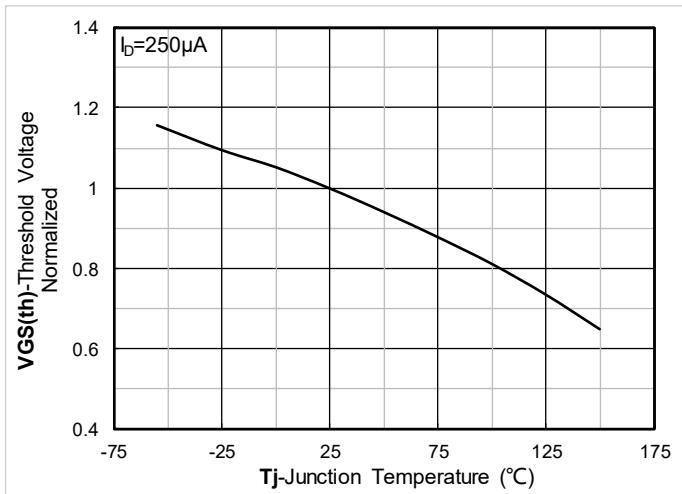


Figure 10. Normalized Threshold voltage

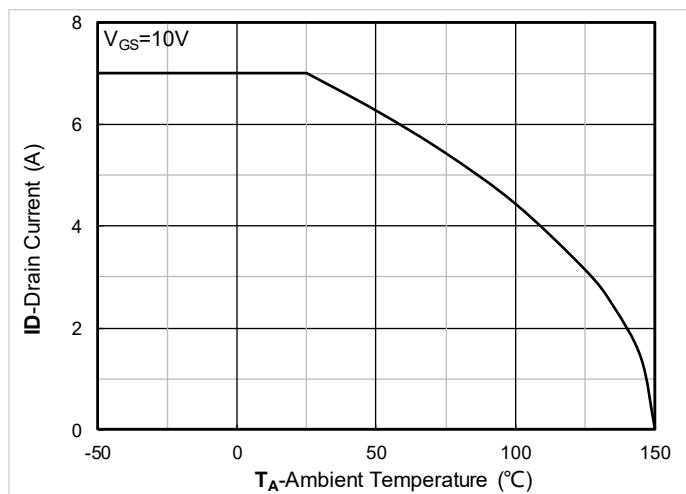


Figure 11. Current dissipation

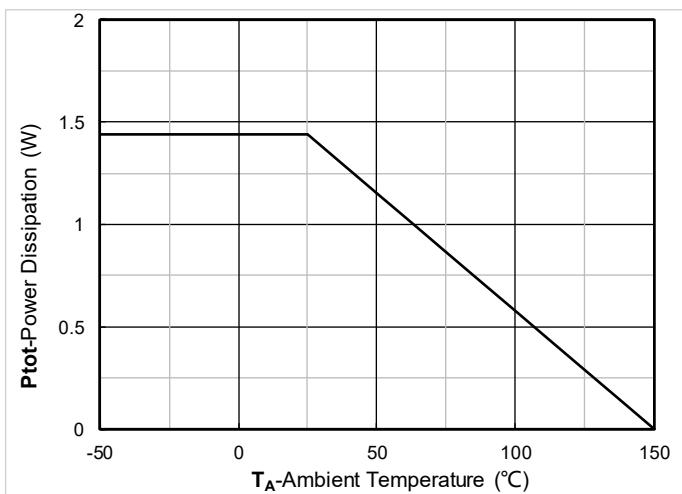


Figure 12. Power dissipation

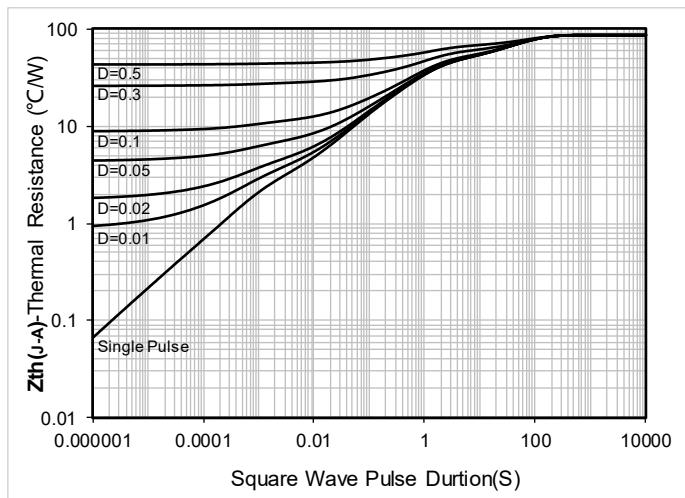


Figure 13. Maximum Transient Thermal Impedance

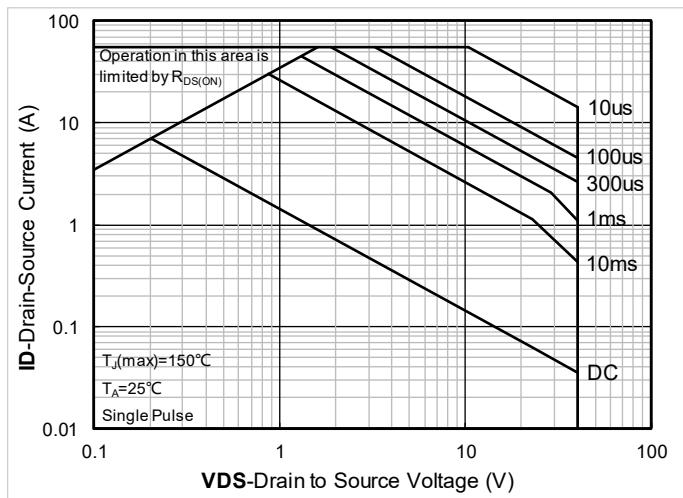


Figure 14. Safe Operation Area

## ■ PMOS Typical Electrical and Thermal Characteristics Diagrams

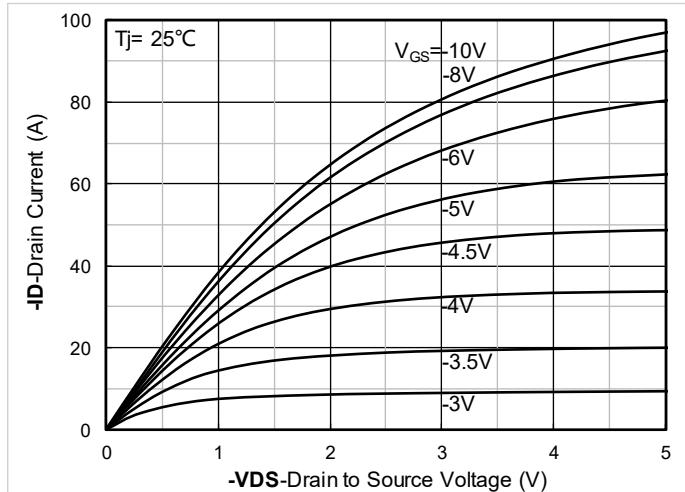


Figure 1. Output Characteristics; typical values

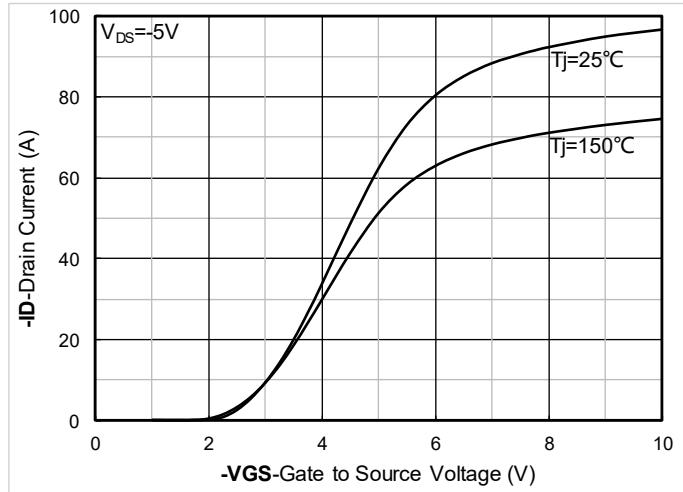


Figure 2. Transfer Characteristics; typical values

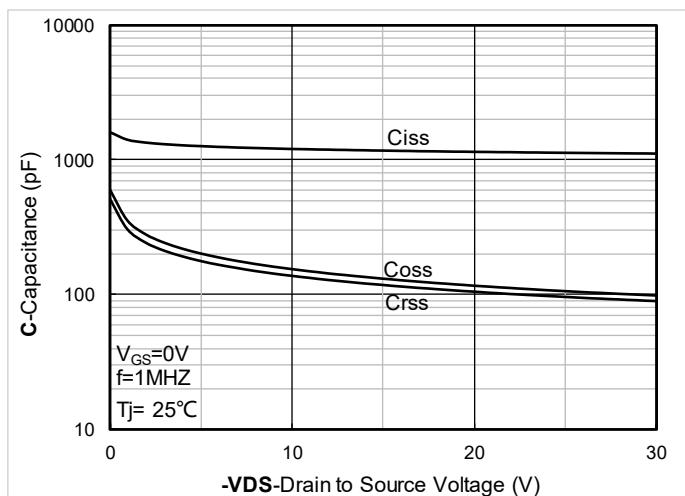


Figure 3. Capacitance Characteristics; typical values

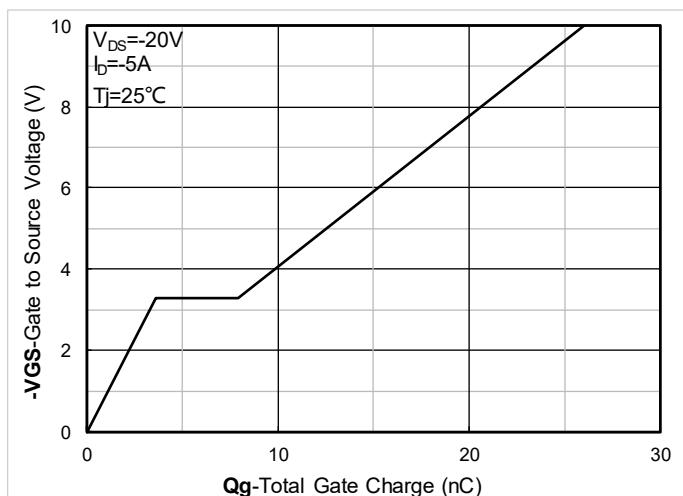


Figure 4. Gate Charge; typical values

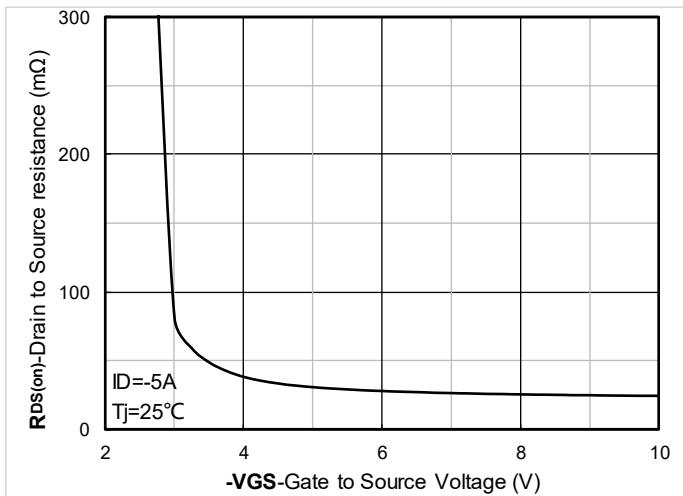


Figure 5. On-Resistance vs. Gate to Source Voltage; typical values

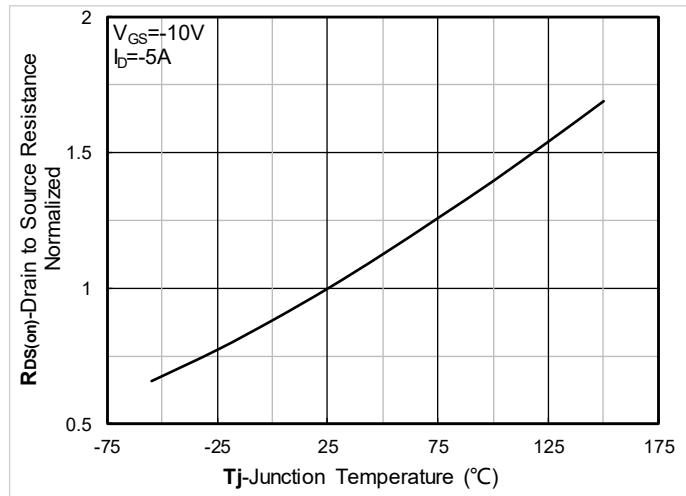


Figure 6. Normalized On-Resistance

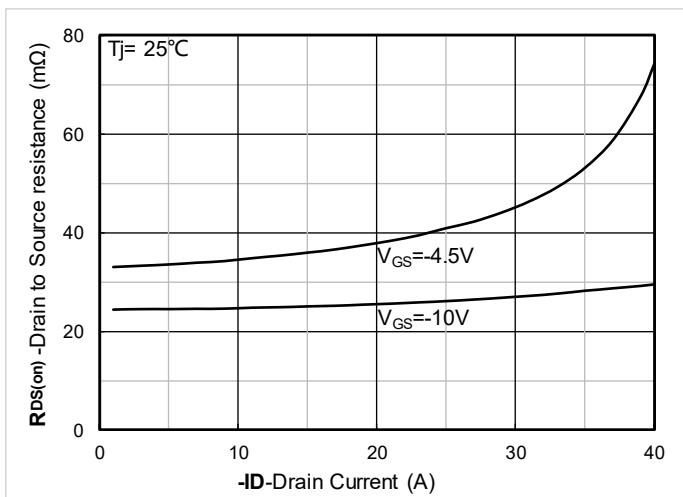


Figure 7. RDS(on) vs. Drain Current; typical values

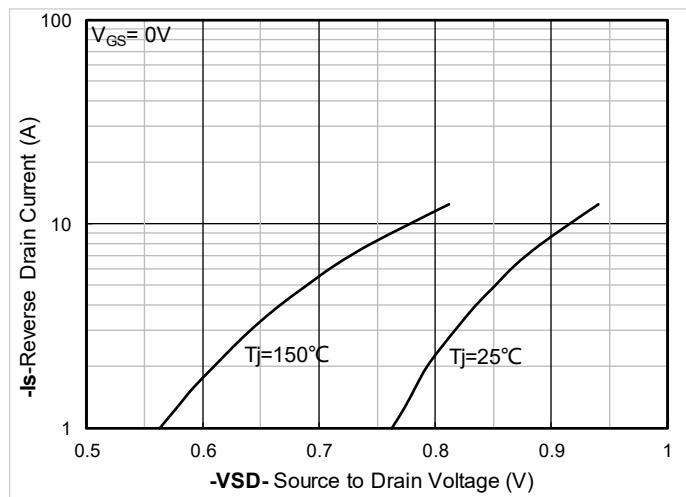


Figure 8. Forward characteristics of reverse diode; typical values

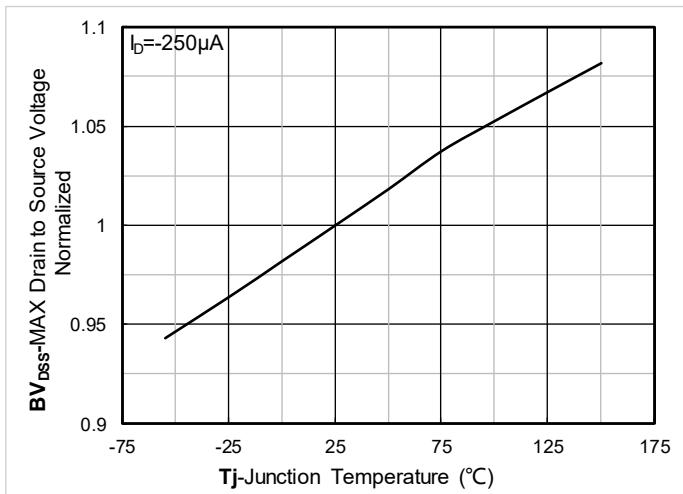


Figure 9. Normalized breakdown voltage

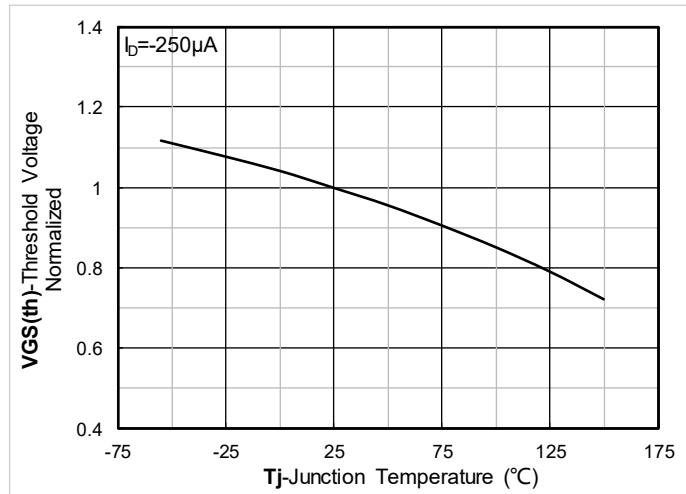


Figure 10. Normalized Threshold voltage

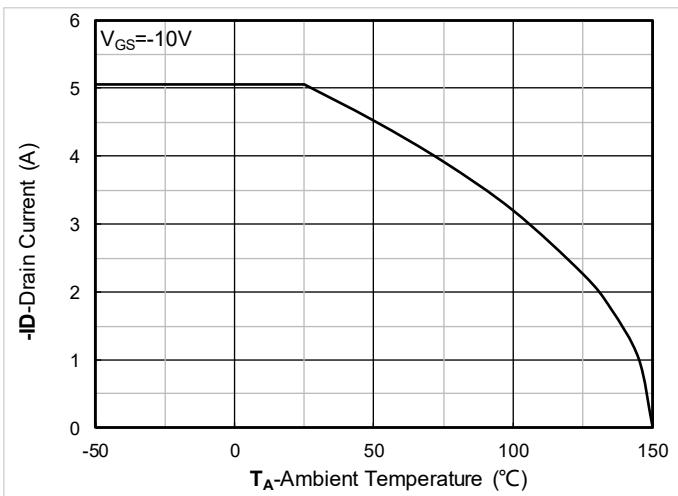


Figure 11. Current dissipation

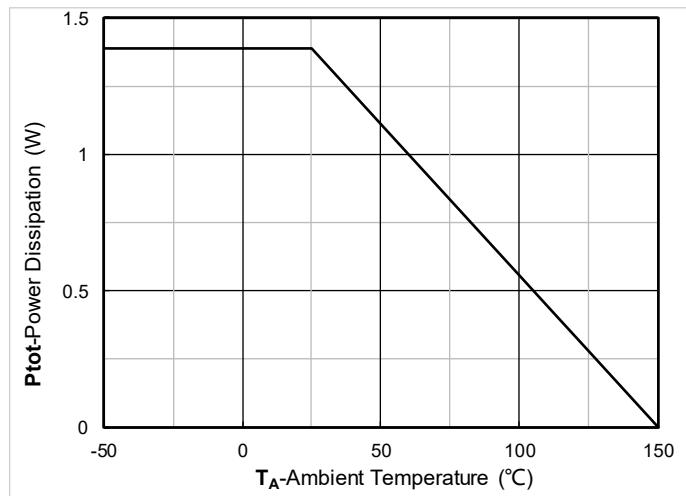


Figure 12. Power dissipation

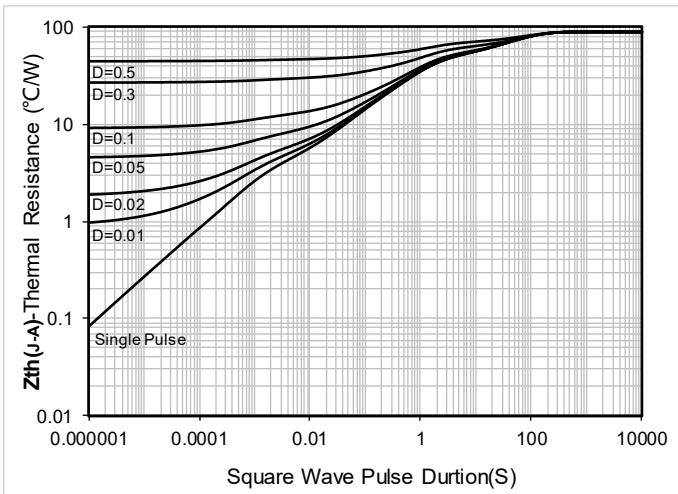


Figure 13. Maximum Transient Thermal Impedance

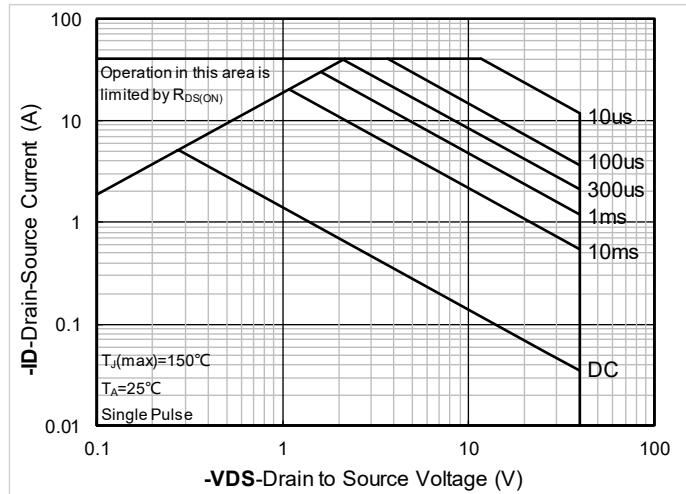
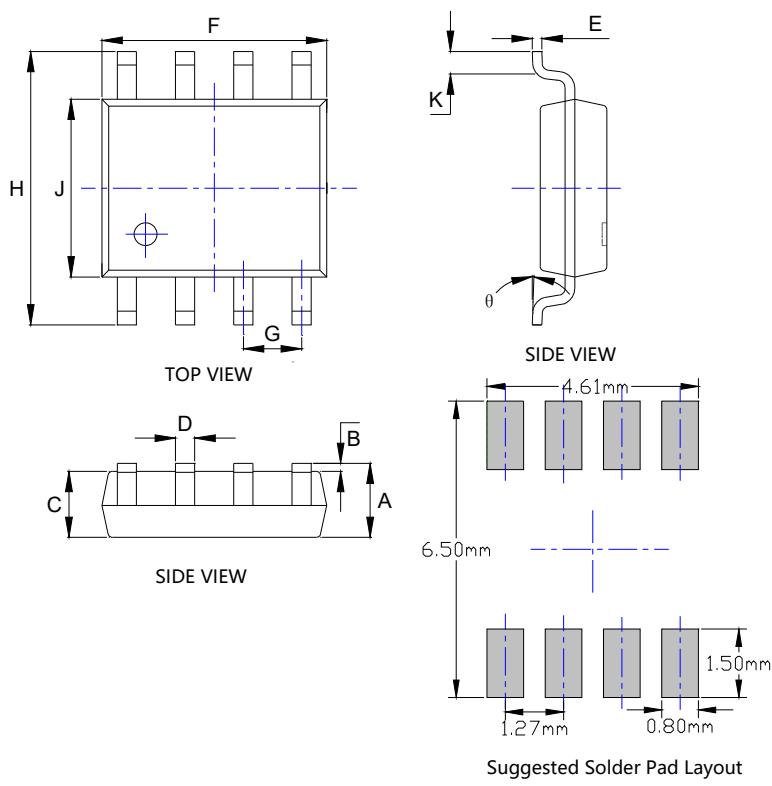


Figure 14. Safe Operation Area

**■ SOP-8 Package information**

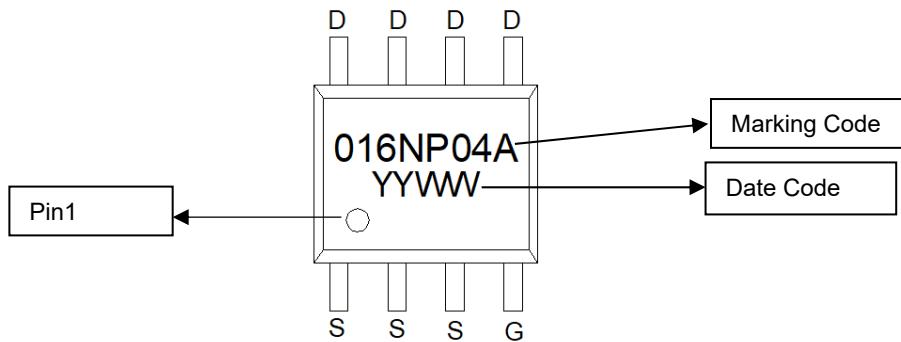
SYMBOL	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.053	0.069	1.350	1.750
B	0.004	0.010	0.100	0.250
C	0.053	0.061	1.350	1.550
D	0.013	0.020	0.330	0.510
E	0.007	0.010	0.170	0.250
F	0.189	0.197	4.800	5.000
G	0.050BSC		1.270BSC	
H	0.228	0.244	5.800	6.200
J	0.150	0.157	3.800	4.000
K	0.016	0.050	0.400	1.270
θ	0°	8°	0°	8°

**Note:**

1. Controlling dimension: in millimeters.
2. General tolerance: +/-0.05mm.
3. The pad layout is for reference purposes only.



## ■ Marking Information



Note:

1. All marking is at middle of the product body
2. All marking is in laser printing
3. 016NP04A is marking code,  
YYWW is date code, "YY" is year, "WW" is week
4. Body color: Black



## Disclaimer

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The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use or sale.

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